

## Preface

2014 Dianchi Advanced Materials Forum was held from July 23 to 25, 2013, at Kunming, China. This forum was co-sponsored by Kunming University of Science and Technology (KUSY) and Shanghai Institute of Technology (SIT). The aim of this Forum is to promote the interactions and cooperations among the scientists, engineers, technicians and students engaged in the field of materials science and engineering.

About 90 scholars and students from universities and institutes in China attended the Forum to give more than 100 presentations.

During the organizing of this Forum, the organizers received 122 manuscripts from the participants. After review process, 77 papers were finally accepted for publication in this Proceedings.

The Editors would like to thank the members of the Organizing Committee and the Academic Committee for their efforts and successful preparation of this event. We would like to thank all colleagues who have devoted much time and effort to organize this meeting. The efforts of the authors and the reviewers of the manuscripts prepared for the proceedings are also gratefully acknowledged.

Hopefully this proceeding would be beneficial to all the participants of the workshop and the readers.

2015 Dianchi Advanced Materials Forum will be held in July of 2015 and we are looking forward to meeting more friends at the forthcoming event.

Prof. Jin Hu  
Kunming University of Science and Technology

Prof. Cheng Zhang  
Shanghai Institute of Technology